

Supplemental Application Data Sheet

Application Information

Application number::	<u>10/534687</u>
Filing Date::	<u>05/12/05</u>
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	ATOMIC LAYER DEPOSITION USING METAL AMIDINATES
Attorney Docket Number::	0042697.00149US3
Request for Early Publication?::	No
Request for Non-Publication?::	No
Small Entity?::	Yes
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	<u>Roy</u>
Middle Name::	<u>G.</u>
Family Name::	<u>GORDON</u>
City of Residence::	<u>Cambridge</u>
State or Province of Residence::	MA <i>MA</i>
Country of Residence::	US
Street of mailing address::	22 Highland Street
City of mailing address::	Cambridge

State or Province of mailing address:: MA
Postal or Zip Code of mailing address:: 02138

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Applicant Authority Type:: Inventor
Status:: Full Capacity
Given Name:: Booyong
Middle Name:: S.
Family Name:: LIM
Country of Residence:: US
State or Province of mailing address:: MA

Correspondence Information

Correspondence Customer Number:: 23483

Representative Information

Representative Customer Number:: 23483

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	371 of	US03/036568	11/14/03
US03/036568	An application claiming the benefit under 35 USC 119(e)	60/426975	11/15/02
US03/036568	An application claiming the benefit under 35 USC 119(e)	60/463365	04/16/03

Foreign Priority Information

Assignee Information

Assignee name:: Harvard University